

VHF push-pull power MOS transistor

BLF378

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69E D

FEATURES

- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability.

DESCRIPTION

Dual push-pull silicon N-channel enhancement mode vertical D-MOS transistor, designed for broadcast transmitter applications in the VHF frequency range.

The transistor is encapsulated in a 4-lead SOT262A1 balanced flange envelope, with two ceramic caps. The mounting flange provides the common source connection for the transistors.

PIN CONFIGURATION

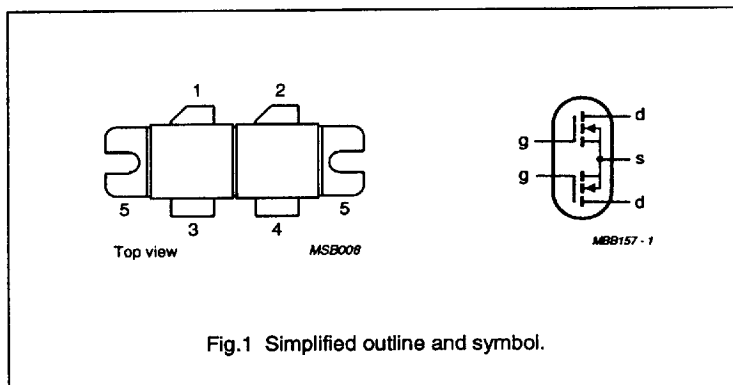


Fig.1 Simplified outline and symbol.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static charge during transport and handling.

PINNING – SOT262 A1

PIN	DESCRIPTION
1	drain 1
2	drain 2
3	gate 1
4	gate 2
5	source

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO discs are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at $T_r = 25\text{ }^\circ\text{C}$ in a push-pull common source test circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	P_L (W)	G_p (dB)	ΔG_p (dB) (note 1)	η_D (%)
CW, class-AB	225	50	250	> 14 typ. 16	< 1 typ. 0.6	> 50 typ. 55

Note

1. Assuming a 3rd order amplitude transfer characteristic, 1 dB gain compression corresponds with 30% synchronized input/25% synchronized output compression in television service (negative modulation, CCIR system).

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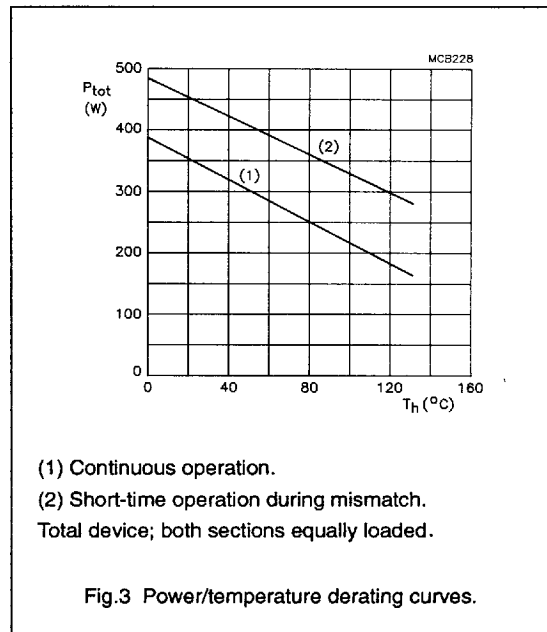
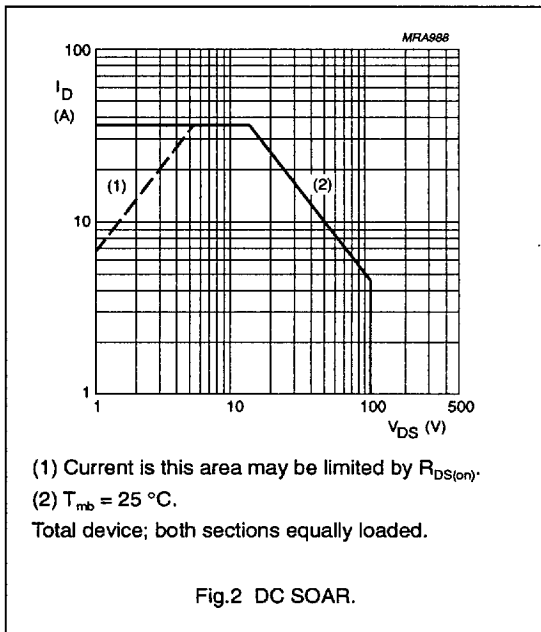
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).
Per transistor section unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	drain-source voltage		-	110	V
$\pm V_{GSS}$	gate-source voltage		-	20	V
I_D	DC drain current		-	18	A
P_{tot}	total power dissipation	up to $T_{mb} = 25^\circ\text{C}$ total device; both sections equally loaded	-	500	W
T_{slg}	storage temperature		-65	150	$^\circ\text{C}$
T_j	junction temperature		-	200	$^\circ\text{C}$

THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	total device; both sections equally loaded	0.35 K/W
$R_{th\ mb-h}$	thermal resistance from mounting base to heatsink	total device; both sections equally loaded	0.15 K/W



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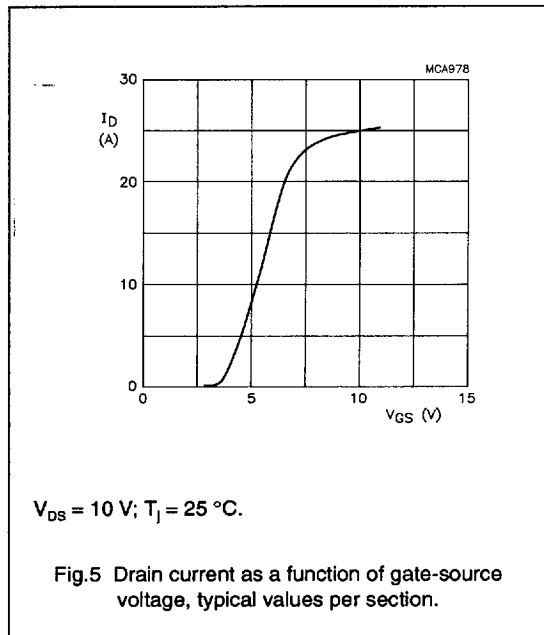
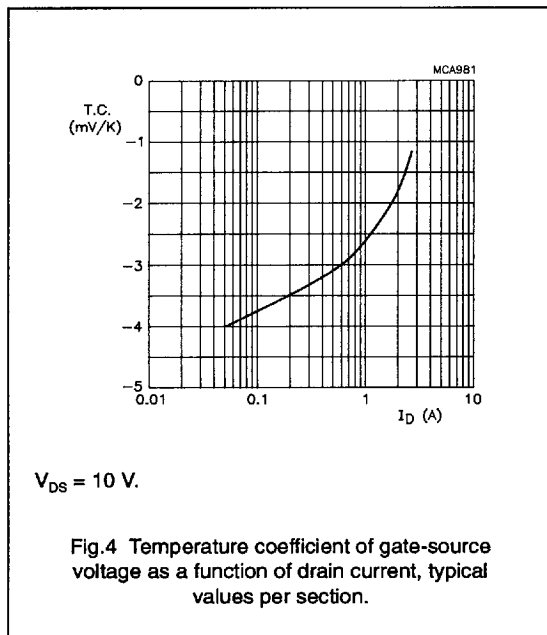
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CHARACTERISTICS (per section)

T_J = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 50 mA	110	-	-	V
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 50 V	-	-	2.5	mA
I _{GSS}	gate-source leakage current	±V _{GS} = 20 V; V _{DS} = 0	-	-	1	µA
V _{GS(th)}	gate-source threshold voltage	I _D = 50 mA; V _{DS} = 10 V	2	-	4.5	V
ΔV _{GS}	gate-source voltage difference of both transistor sections	I _D = 50 mA; V _{DS} = 10 V	-	-	100	mV
g _{fs}	forward transconductance	I _D = 5 A; V _{DS} = 10 V	4.5	6.2	-	S
g _{fs1} /g _{fs2}	forward transconductance ratio of both transistor sections	I _D = 5 A; V _{DS} = 10 V	0.9	-	1.1	
R _{DS(on)}	drain-source on-state resistance	I _D = 5 A; V _{GS} = 10 V	-	0.2	0.3	Ω
I _{DSX}	on-state drain current	V _{GS} = 10 V; V _{DS} = 10 V	-	25	-	A
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 50 V; f = 1 MHz	-	480	-	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 50 V; f = 1 MHz	-	190	-	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 50 V; f = 1 MHz	-	14	-	pF
C _{d-f}	drain-flange capacitance		-	5.4	-	pF

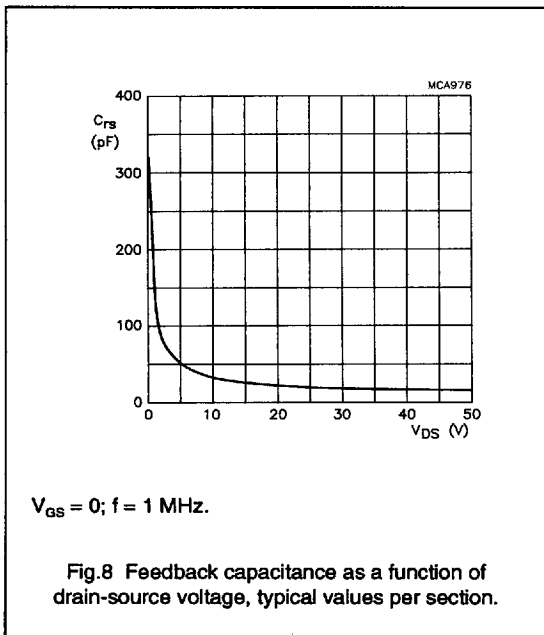
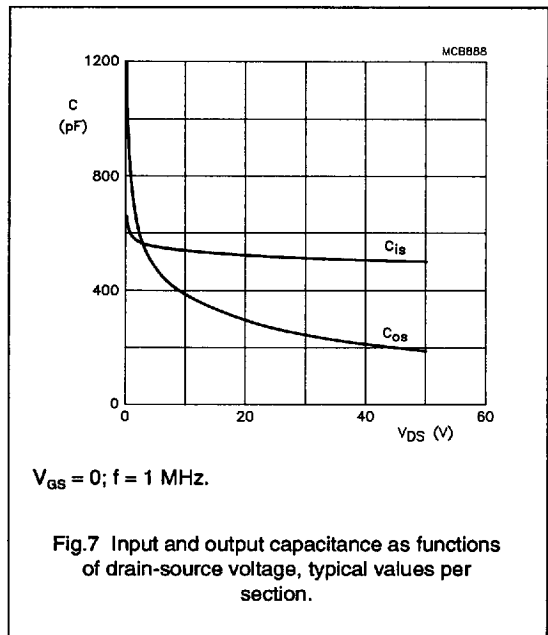
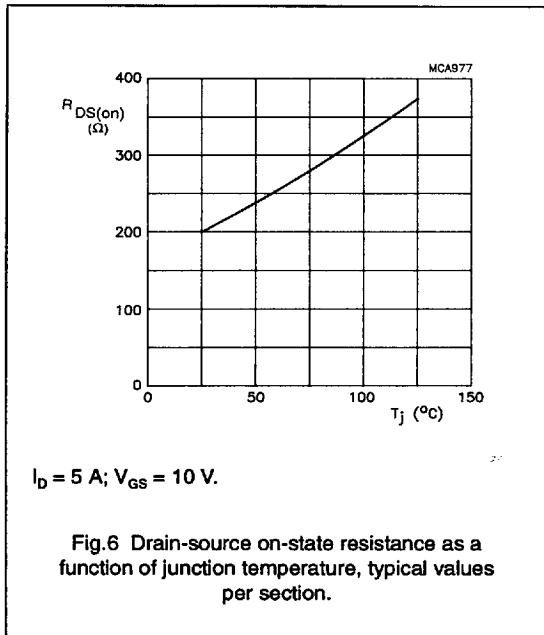


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APPLICATION INFORMATION FOR CLASS-AB OPERATION

$T_h = 25\text{ }^\circ\text{C}$; $R_{th\text{ mb-h}} = 0.15\text{ K/W}$ unless otherwise specified.

RF performance in CW operation in a common source class-AB circuit.

$R_{GS} = 2.8\ \Omega$ per section; optimum load impedance per section = $0.74 + j2\ \Omega$ ($V_{DS} = 50\text{ V}$).

MODE OF OPERATION	f (MHz)	V_{DS} (V)	I_{DQ} (A)	P_L (W)	G_p (dB)	ΔG_p (dB) (note 1)	η_D (%)
CW, class-AB	225	50	2 x 0.5	250	> 14 typ. 16	< 1 typ. 0.6	> 50 typ. 55
CW, class-AB	225	45	2 x 0.5	250	typ. 15	typ. 1	typ. 60

Note

- Assuming a 3rd order amplitude transfer characteristic, 1 dB gain compression corresponds with 30% synchronized input/25% synchronized output compression in television service (negative modulation, CCIR system).

Ruggedness in class-AB operation

The BLF378 is capable of withstanding a load mismatch corresponding to $V_{SWR} = 7$ through all phases under the following conditions:

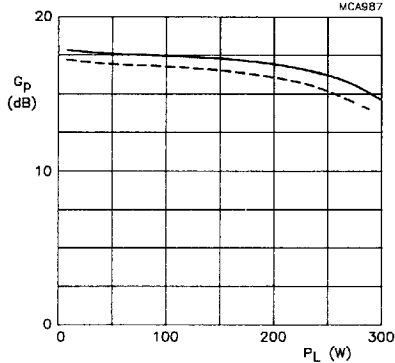
$V_{DS} = 50\text{ V}$; $f = 225\text{ MHz}$ at rated output power.

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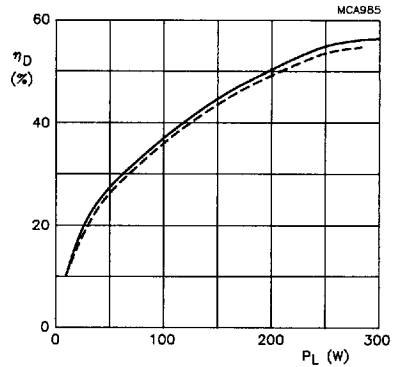
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Class-AB operation; $V_{DS} = 50 \text{ V}$; $I_{DQ} = 2 \times 0.5 \text{ A}$; $Z_L = 0.74 + j2 \ \Omega$ (per section); $R_{GS} = 2.8 \ \Omega$ (per section); $f = 225 \text{ MHz}$.

solid line: $T_h = 25 \text{ }^\circ\text{C}$. dotted line: $T_h = 70 \text{ }^\circ\text{C}$.

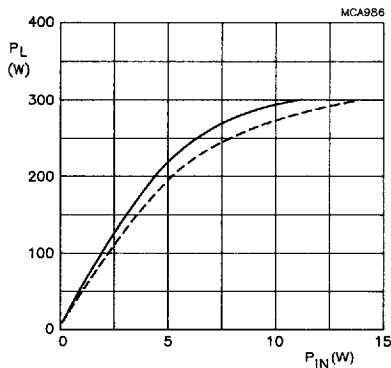
Fig.9 Power gain as a function of load power, typical values per section.



Class-AB operation; $V_{DS} = 50 \text{ V}$; $I_{DQ} = 2 \times 0.5 \text{ A}$; $Z_L = 0.74 + j2 \ \Omega$ (per section); $R_{GS} = 2.8 \ \Omega$ (per section); $f = 225 \text{ MHz}$.

solid line: $T_h = 25 \text{ }^\circ\text{C}$. dotted line: $T_h = 70 \text{ }^\circ\text{C}$.

Fig.10 Efficiency as a function of load power, typical values per section.



Class-AB operation; $V_{DS} = 50 \text{ V}$; $I_{DQ} = 2 \times 0.5 \text{ A}$; $Z_L = 0.74 + j2 \ \Omega$ (per section); $R_{GS} = 2.8 \ \Omega$ (per section); $f = 225 \text{ MHz}$.

solid line: $T_h = 25 \text{ }^\circ\text{C}$. dotted line: $T_h = 70 \text{ }^\circ\text{C}$.

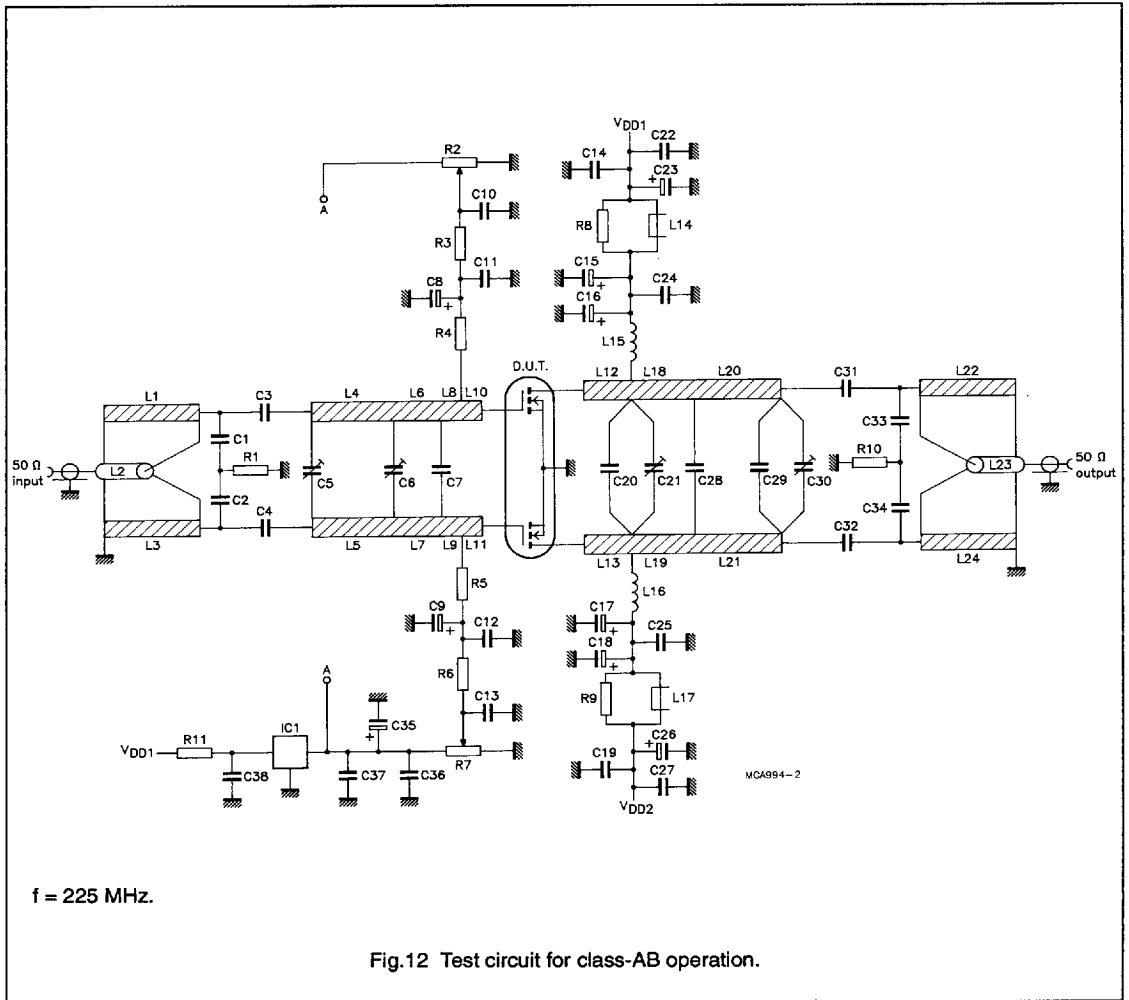
Fig.11 Load power as a function of input power, typical values per section.

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List of components (class-AB test circuit)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C2	multilayer ceramic chip capacitor (note 1)	27 pF, 500 V		
C3, C4, C31, C32	multilayer ceramic chip capacitor (note 1)	3 x 18 pF in parallel, 500 V		
C5	film dielectric trimmer	4 to 40 pF		2222 809 08002
C6, C30	film dielectric trimmer	2 to 18 pF		2222 809 09006
C7	multilayer ceramic chip capacitor (note 1)	100 pF, 500 V		
C8, C9, C15, C18	MKT film capacitor	1 μ F, 63 V		2222 371 11105
C10, C13, C14, C19, C36	multilayer ceramic chip capacitor	100 nF, 50 V		2222 852 47104
C11, C12	multilayer ceramic chip capacitor (note 1)	2 x 1 nF in parallel, 500 V		
C16, C17	electrolytic capacitor	220 μ F, 63 V		
C20	multilayer ceramic chip capacitor (note 1)	3 x 33 pF in parallel, 500 V		
C21	film dielectric trimmer	2 to 9 pF		2222 809 09005
C22, C27, C37, C38	multilayer ceramic chip capacitor (note 1)	1 nF, 500 V		
C23, C26, C35	electrolytic capacitor	10 μ F, 63 V		
C24, C25	multilayer ceramic chip capacitor (note 1)	2 x 470 pF in parallel, 500 V		
C28	multilayer ceramic chip capacitor (note 1)	2 x 10 pF in parallel + 18 pF, 500 V		
C29	multilayer ceramic chip capacitor (note 1)	2 x 5.6 pF in parallel, 500 V		
C33, C34	multilayer ceramic chip capacitor (note 1)	5.6 pF, 500 V		
L1, L3, L22, L24	stripline (note 2)	50 Ω	4.8 x 80 mm	
L2, L23	semi-rigid cable (note 3)	50 Ω	ext. conductor length 80 mm ext. dia 3.6 mm	
L4, L5	stripline (note 2)	43 Ω	6 x 24 mm	
L6, L7	stripline (note 2)	43 Ω	6 x 14.5 mm	
L8, L9	stripline (note 2)	43 Ω	6 x 4.4 mm	
L10, L11	stripline (note 2)	43 Ω	6 x 3.2 mm	
L12, L13	stripline (note 2)	43 Ω	6 x 15 mm	
L14, L17	grade 3B Ferroxcube wideband HF choke	2 in parallel		4312 020 36642

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COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
L15, L16	1 $\frac{3}{4}$ turns enamelled 2 mm copper wire	40 nH	space 1 mm int. dia. 10 mm leads 2 x 7 mm	
L18, L19	stripline (note 2)	43 Ω	6 x 13 mm	
L20, L21	stripline (note 2)	43 Ω	6 x 29.5 mm	
R1	0.4 W metal film resistor	10 Ω		
R2, R7	10 turns potentiometer	50 k Ω		
R3, R6	0.4 W metal film resistor	1 k Ω		
R4, R5	0.4 W metal film resistor	2 x 5.62 Ω in parallel		
R8, R9	1 W, \pm 5% metal film resistor	10 Ω		
R10	1 W metal film resistor	4 x 42.2 Ω in parallel		
R11	1 W metal film resistor	5.11 k Ω		
IC1	voltage regulator 78L05			

Notes

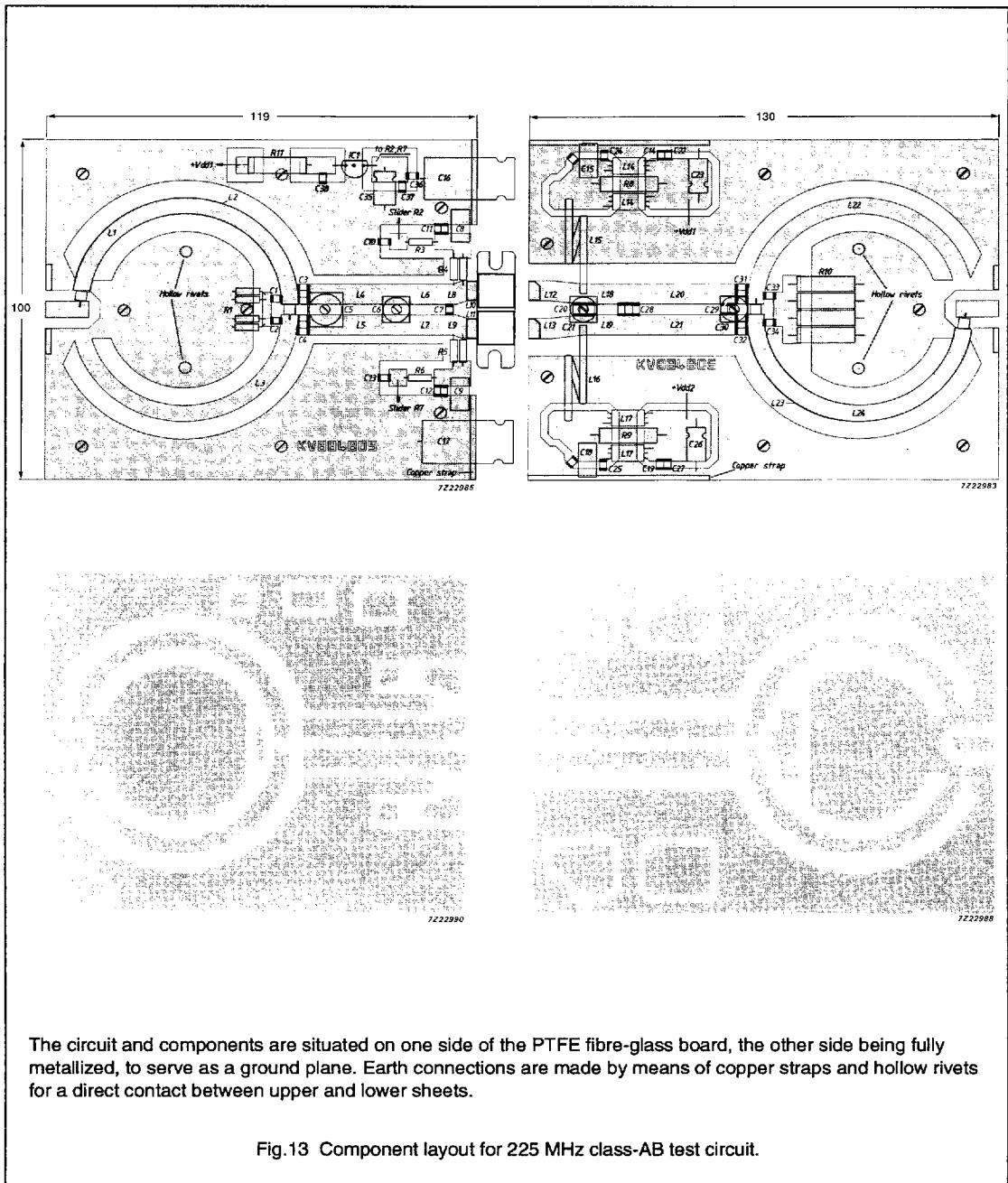
- American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- The striplines L1, L3 - L13, L18 - L22 and L24 are on a double copper-clad printed circuit board with glass microfibre PTFE dielectric ($\epsilon_r = 2.2$); thickness $\frac{1}{16}$ inch; thickness of copper sheet 2 x 35 μm .
- Semi-rigid cables L2 and L23 are soldered on to striplines L1 and L24.

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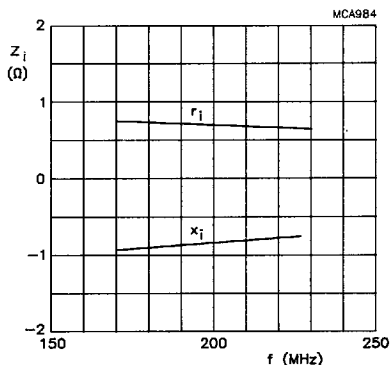


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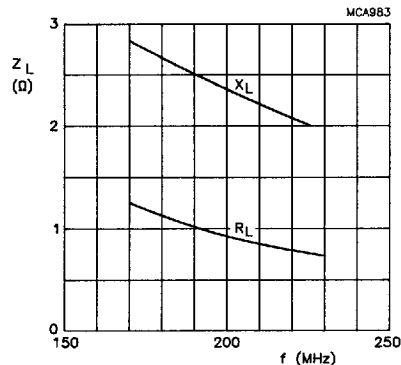
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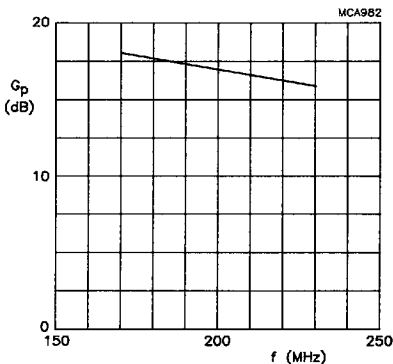
Class-AB operation; $V_{DS} = 50$ V; $I_{DO} = 2 \times 0.5$ A; $R_{GS} = 2.8 \Omega$ (per section); $P_L = 250$ W.

Fig.14 Input impedance as a function of frequency (series components), typical values per section.



Class-AB operation; $V_{DS} = 50$ V; $I_{DO} = 2 \times 0.5$ A; $R_{GS} = 2.8 \Omega$ (per section); $P_L = 250$ W.

Fig.15 Load impedance as a function of frequency (series components), typical values per section.



Class-AB operation; $V_{DS} = 50$ V; $I_{DO} = 2 \times 0.5$ A; $R_{GS} = 2.8 \Omega$ (per section); $P_L = 250$ W.

Fig.16 Power gain as a function of frequency, typical values per section.